MIP708

Silicon MOS IC

Features

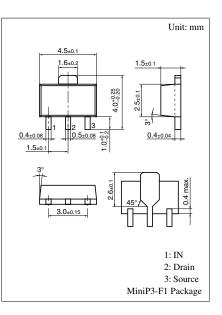
- 3-pin intelligent power device
- Five protective functions (over-current, over-voltage, short circuit load, over heat, ESD) built-in
- Acceptable both AC and DC power supply

Applications

• For lamp and solenoid drive

Paramete	er	Symbol	Ratings	Unit	
Output voltage		V _{DS}	40	V	
Output peak current		I _{OP}	±3	А	
Output current		Io	±1	А	
Input voltage		V _{IN}	- 0.5 to 6	V	
Input current		I _{IN}	±5	mA	
Drain clamp energy		E _{CLP}	24*1	mJ	
Allowable power	$Ta = 25^{\circ}C$	P _{D1}	1*2	W	
dissipation	$T_C = 25^{\circ}C$	P _{D2}	2	W	
Operating ambient temperature		T _{opr}	-40 to +125	°C	
Channel temperature		T _{ch}	150	°C	
Storage temperature		T _{stg}	-55 to +150	°C	

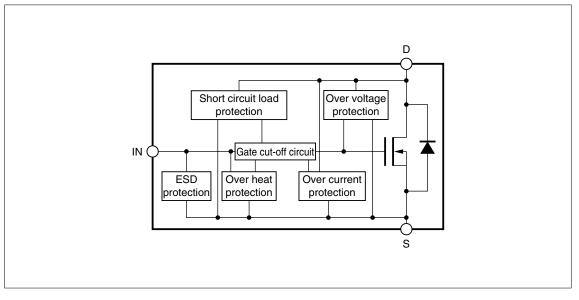
■ Absolute Maximum Ratings (Ta = 25°C)



^{*1} L = 10mH, I_L = 2.19A, V_{DD} = 20V, 1pulse, T_C = 25°C

^{*2} Mounting on the PCB (the copper foil of the drain portion has a area of 100mm² or more and the thickness of glass epoxy board is 1.7mm.)

Block Diagram



Parameter	Symbol	Conditions	min	typ	max	Unit
Drain to Source ON-resistance	R _{DS(on)}	$V_{IN} = 5V, I_{DS} = 1A$		0.5	0.8	Ω
Drain to Source ON-voltage	V _{DS(on)}	$V_{IN} = 5V, I_{DS} = 1A$		0.5	0.8	v
Drain clamp voltage	V _{DS(CLP)}	$V_{IN} = 0$, $I_{DS} = 3mA$	40	49		v
Drain OFF current (1)	I _{DS(off)1}	$V_{IN} = 0, V_{DS} = 12V$		50	100	μΑ
Drain OFF current (2)	I _{DS(off)2}	$V_{\rm IN}=0,V_{\rm DS}=16V$		70	140	mA
Input voltage (High)	V _{IN(H)}	$I_{DS} = 1A$	4			v
Input voltage (Low)	V _{IN(L)}	$I_{DS} = 1mA$			0.8	V
Input current	I _{IN(on)}	$V_{IN} = 5V, V_{DS} = 0$		0.15	1	mA
Over current protection limit	I _{OCP}	$V_{IN} = 5V$	2	3		A
Short circuit load protection limit	V _{DS(SHT)}	$V_{IN} = 5V$	2	4		V

Electrical Characteristics ($T_c = 25 \pm 3^{\circ}C$)

Note: The oscillation of the output current is caused when the drain voltage exceeds the short circuit load detection voltage under the ON state of output.

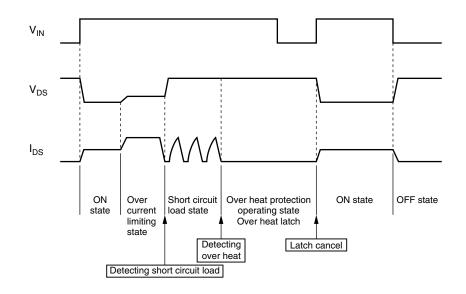
Electrical Characteristics ($T_C = 25 \pm 2^{\circ}C$)

Parameter	Symbol	Conditions	min	typ	max	Unit
Over heat protection temperature	T _{SHD}	$V_{IN} = 5V$	160	190		°C
Turn on delay time	t _{d(on)}			1		μs
Turn-on time	t _{on}	$V_{IN} = 5V, I_{DS} = 1A$		5.5		μs
Turn off delay time	t _{d(off)}	$V_{DD} = 12V, R_L = 12\Omega$		3.4		μs
Turn-off time	t _{off}			7.2		μs

Note 1: The above values of characteristics are not guaranteed values and are only references for designing.

Note 2: If the chip temperature exceeds the "Over Heat Protection Temperature", output current is shut down.

Timing Chart



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